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	C CONNECTOR _LF/SFW_ R-3/4STGE_ LF)	1 of 11 AUTHORIZED BY M.YAMASHITA	E DATE 24 Nov 09
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1. SCOPE

This specification covers the requirements for the connector (SFW__R-3/4ST_E_LF) with 1mm spacing to which the edge of FPC(Flexible Printed Circuit) can be connected by Zero-Insertion-Force method and which copes with automatic mounting and SMT.

2. APPLICABLE STANDARDS

JIS C 5402

Method for Test of Connectors for Electronic Equipment

JIS C 0806

Packaging of Electronic Components on Continuous Tapes

(Surface Mount Components)

UL - 94

TESTS FOR FLAMMABILITY OF PLASTIC MATERIALS FOR PARTS

IN DEVICES AND APPLIANCES

3. CATALOG NO. STRUCTURE

	<u>SFW 20</u>	R - 3	ST	G E1	LF
Series					
Number of Contacts ——————					
Right Angle —————					
For FPC, Contact direction 3: Lower contact type 4: Upper contact type					
Cope with automatic mounting & SMT -					
Plating Variation A: Selective Gold plating G: Gold plating (ALL)		1 11 11 11 11 11 11 11 11 11 11 11 11 1	,		
Plastic Tape Packaging					
Lead Free					

- 4. CONNECTOR SHAPE, DIMENSIONS AND MARTERIALS Refer product drawings.
- 5. ACCOMMODATED CONDUCTORS (FPC) Refer product drawings.
- 6. PACKAGING CONDITION Refer product drawings.
- 7. RECOMMENDED MOUNTING PATTERN DIMENSIONS Refer product drawings.

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8. RATING

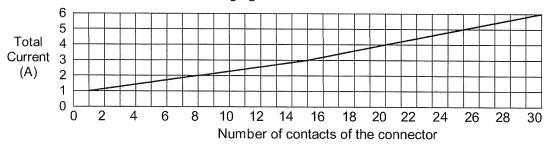
8-1. Voltage : A.C. 100V D.C. 100V

8-2. Current : A.C. 1A D.C. 1A (Refer to the following note.)

8-3. Operating Temperature : -55°C ~ +105°C (Including terminal temperature rise)

NOTE

Allowable maximum current for one contact is 1A. Total allowable current for a whole connector is the value which is shown in the following figure.



9. PERFORMANCE CHARACTERISTICS

9-1 Flectrical Performance

r	Took Item	T	T
No.	Test Item	Test Method	Requirements
9-1-1	Contact resistance	1) Measure contact resistance between V ₁ -V ₂ by voltage drop method by the following circuit by mating accommodated conductor stipulated in clause 5 after reflow soldering the connector on the P.C.B. and cleaning flux dregs. Connductor Soldering Portion V1 Pattern V1 Smm V2 Pattern V2 Pattern V2 Pattern V3 P.C.B. Smm V2 Pattern V3 P.C.B. Smm V2 Pattern V3 P.C.B. Smm V4 Pattern V6 P.C.B. Smm V8 P.C.B. Smm V8 P.C.B. Smm V9 Pattern V9 Pattern V1 Smm V1 Smm V2 Pattern V2 Pattern V3 P.C.B. Smm V4 Pattern V6 P.C.B. Smm V8 P.C.B. Smm V8 P.C.B. Smm V9 Pattern V9 Pattern V1 Smm V1 Smm V2 Pattern V2 Pattern V3 Pattern V4 Pattern V6 P.C.B. Smm P.C.B. Smm	 Initial value Less than 30mΩ Contact resistance after the test Is in accordance with the value specified in each test item.

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No.	Test Item	Test Method	Requirements
9-1-2	Insulation resistance	Measure insulation resistance between adjacent contacts in a connector individual. Test voltage: D.C. 500V Read value one minute after applying test voltage.	1) More than 500MΩ
9-1-3	Dielectric withstanding voltage	For one minute, apply A.C. 500V between adjacent contacts in a connector individual. Set current : A.C. 1mA	Free from any short circuit and insulation breakdown.

9-2. Mechanical Performance

No.	Test Item	Test Method	Requirements
9-2-1	Durability (Slider operation)	Measure contact resistance before and after the test by the method in clause 9-1-1 by mating the accommodated conductor specified in clause 5. Number of slider open and close: 20 times (Insert and extract the conductor for each opening of the slider.)	 Initial contact resistance : Less than 30mΩ Contact resistance after the test : Less than 50mΩ Free from any defect such as break etc. on the connector and the conductor.
9-2-2	Vibration (Sinusoidal)	JIS C 60068-2-6 (IEC60068-2-6) 1) Frequency range: 10 ~ 500Hz 2)Amplitude: 0.75mm or Acceleration: 100m/s² 3) Sweep rate: 1 octave / minute 4) Kind of test: Sweep endurance test 5) Test time: 10 cycles	 During the test, no circuit opening for more than 1μs Free from any defect such as break, deformation, loosing and falling off etc. on each portion of the connector.

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9-3. Environmental Performance

No.	Test Item	Test Method	Requirements
9-3-1	Damp heat (Steady state)	 JIS C 60068-2-78 (IEC60068-2-78) 1) Measure contact resistance before and after the test by the method in clause 9-1-1 by using the accommodated conductor specified in clause 5. 2) Measure insulation resistance after the test by the method in clause 9-1-2. 3) Bath temperature : 40°C 4) Bath humidity: 90~95% (Relative humidity) 5) Period of exposure : 48 hours 6) Expose conductor and connector in mated condition and leave them under normal temperature. (Without insertion and separation) 	 Initial contact resistance : Less than 30mΩ Contact resistance after the test : Less than 50mΩ Insulation resistance after the test : More than 100MΩ
9-3-2	Salt spray	 JIS C 60068-2-11 (IEC60068-2-11) 1) Measure contact resistance before and after the test according to the method in clause 9-1-1 by using accommodated conductor specified in clause 5. 2) Salt solution concentration: 5% 3) Period of exposure: 48 hours 4) Expose conductor and connector in mated condition and leave them under normal temperature after post treatment. 	 Initial contact resistance : Less than 30mΩ Contact resistance after the test : Less than 50mΩ

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No.	Test Item	Test Method	Requirements
9-3-3	Change of temperature	JIS C 0025 (IEC60068-2-14) 1) Measure contact resistance before and after the test according to the method in clause 9-1-1 by using accommodated conductor in clause 5. 2) One cycle of temperature is as follow and test 5 cycles. Step Temp.(°C) Time (min.) 1 -55±3 30 2 25±2 2 ~ 3 3 85±2 30 4 25±2 2 ~ 3 3) Expose conductor and connector in mated condition and leave them under normal temperature.	1) Initial contact resistance : Less than 30mΩ

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No.	r performance Test Item	Test Method	Requirements
9-4-1	Soldering (Resistance to reflow soldering)	JIS C 60068-2-58 (IEC60068-2-58) 1) Solder by setting reflow bath on the following condition. 2) Preheating: 150~180°C, 120±5s 3) Soldering: 220°C min. 60s max. 4) Peak: 245°C min. 20s max. (Peak 255°C max.) (See Diagram A) Note: Temperature must be measured at contact terminal portion and peak temperature on the upper surface of P.C.B must be less than 260°C. 5) Solder paste to be used is JIS Z 3282 Sn96.5Ag3.0Cu0.5	 Requirements Contact resistance after the test: Less than 50mΩ Insulation resistance after the test: More than 100MΩ No short circuit and insulation Breakdown for dielectric withstanding voltage test after this test. Free from any damage on performance and contact performance after soldering.
		Diagram A 245 220 180 150 Resistance	Peak 255°C 20s max. 5s 60s max. TIME to reflow soldering profile

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No.	Test Item	Test Method	Requirements		
9-4-2	Soldering (Solderability) (Reflow)	JIS C 60068-2-58 (IEC60068-2-58) 1) Solder by setting reflow bath on the following condition. 2) Preheating: 150~180°C, 60~120s 3) Soldering: 225°C min., 20±5s	1) Actual soldered area must be more than 95% of the dipped area intended to be soldered.		
		Diagram B Peak 235°C Peak 235°C 180 60~120s TIME Solderability profile			
9-4-3	Conductor retention force (Reference)	Measure initial retention force after inserted and locked by using accommodated conductor specified in clause 5.	More than 0.49N/contact for FPC (More than 50gf/contact for FPC)		

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10. INDICATION AND PACKAGING

10-1. Indication

- 1) Catalog number and lot number are not indicated on the connector.
- 2) Catalog number and quantity shall be indicated on the surface of the package box.

10-2. Packaging

1) The connector individuals are packed by tapes with specified quantity in accordance with [JIS C 0806 "Packaging of Electronic Components on Continuous Tapes (Surface Mount components)"] and put into package box in accordance with FCI packaging specification.

11. REMARKS

- 11-1. Please refer to the "Handling procedures and remarks" before use.
- 11-2. Retention force for accommodated conductor specified in clause 9-4-3 differs due to its kind. structure and surface treatment of conductor. Therefore, the value of retention force specified in the clause for performance is reference value.
- 11-3. Please use for Gold plating FPC as accommodated conductor.

12. RECOMMENDED REFLOW PROFILE

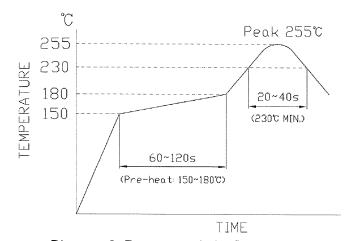


Diagram C. Recommended reflow temperature profile

Note: Please check the reflow soldering condition for your own application beforehand due to different conditions with soldering devices, P.C. Boards, etc. No moisture treatment before reflow process.

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13. REVISION RECORD

REV.	PAGE	DESCRIPTION	ECR#	DATE
Α	All	New release	J05-0024	20 Jan 05
В	5	Correct solder operation to slider operation	J06-0080	01 Mar 06
С	All 3	Revise format of product spec. Operating Temperature change from -55°C ~ +85°C to -55°C ~ +105°C	S07-0192	21 Mar 07
D	All	Revise spec for lead-free solder Add "Diagram A" Resistance to Reflow Soldering Profile. Add "Diagram B" Solderability Profile. Add "Diagram C" Recommended Reflow Profile.	J09-0371	16 Oct 09
E	11	Corrected paragraph Number.	J09-0410	24 Nov 09



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